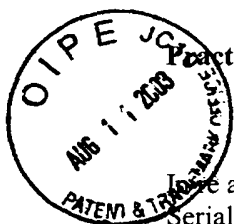


2811



Practitioner's Docket No. U 013887-9

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: SUNG-FEI WANG, et al.

Serial No.: 10/087,432

Filed: March 1, 2002

For: Stacked semiconductor chip package

Group No.: 2811

Examiner: --

Commissioner for Patents

P. O. Box 1450

Alexandria, VA 22313-1450

REQUEST FOR COPY OF REFERENCE AND OR OTHER INFORMATION

RE: OFFICE ACTION

1. The Office Action mailed on July 30, 2003 has been received.
2. The Cited References \_\_\_\_\_  
[X] were not attached.  
[ ] were attached with pages missing.  
[ ] were incorrect: reference \_\_\_\_\_ was sent and is returned herewith.
3. Other:
4. It is requested that a copy of the cited reference should be furnished and the period allowed for response to the Office Action should be restarted.

Reg. No.: 25,858

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SIGNATURE OF PRACTITIONER

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I hereby certify that, on the date shown below, this correspondence is being:

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